

Beam test result of the C- μ RGroove

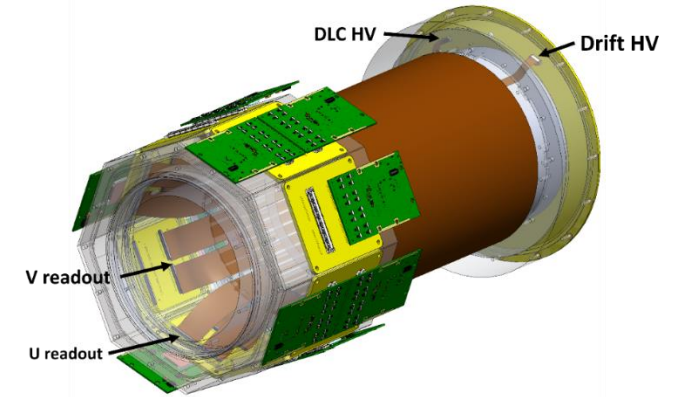
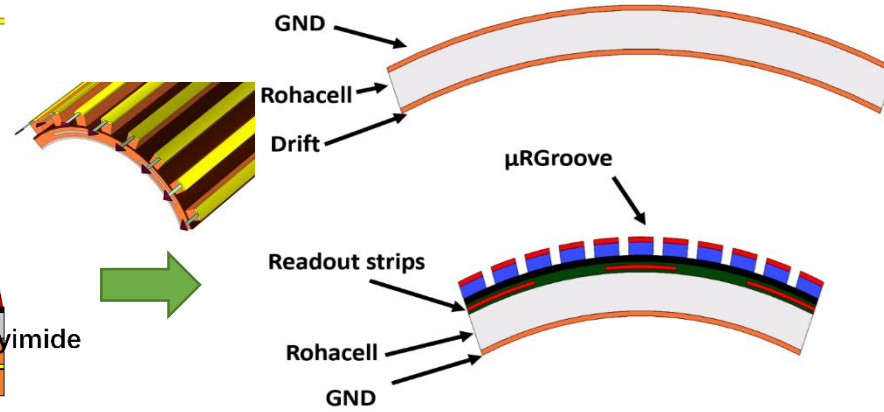
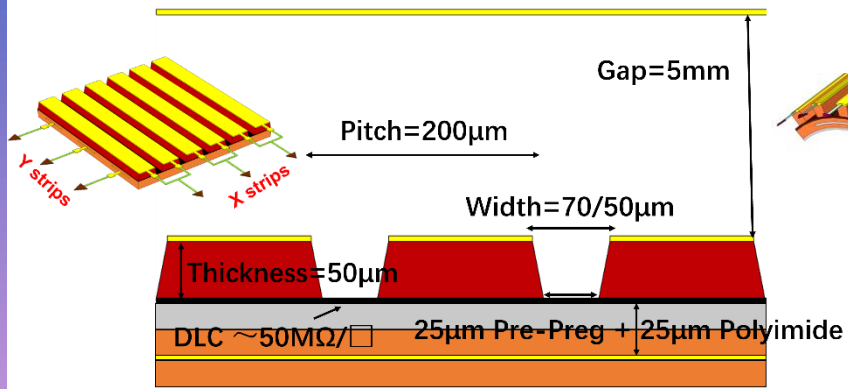
Siqi HE

On behalf of USTC-MPGD Group

3rd DRD1-WG7, 12/12/2024

- **Introduction**
- **Result without magnetic field**
- **Preliminary result with magnetic field**
- **Summary**

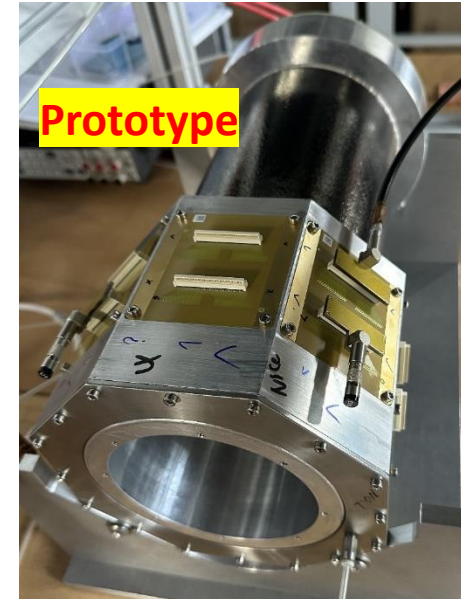
Cylindrical μ RGroove



□ 1st C- μ RGroove prototype:

- Size of active area: $D=131.0\text{mm}$, $L=100.0\text{mm}$;
- Out cylinder is drift and inner is μ RGroove-PCB
- Detachable mechanical design
- Low-mass electrode design
- Vacuum gluing process

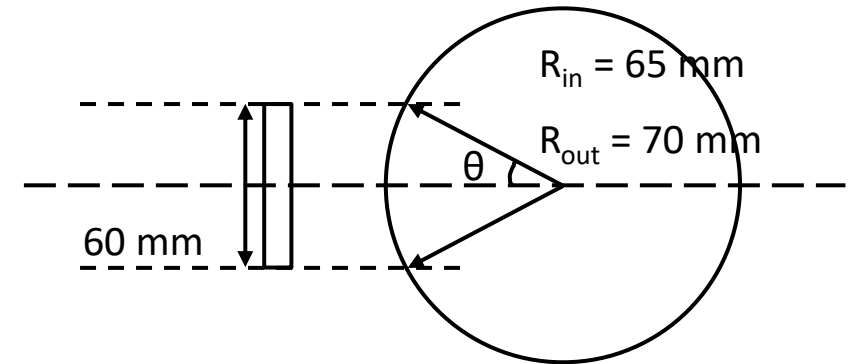
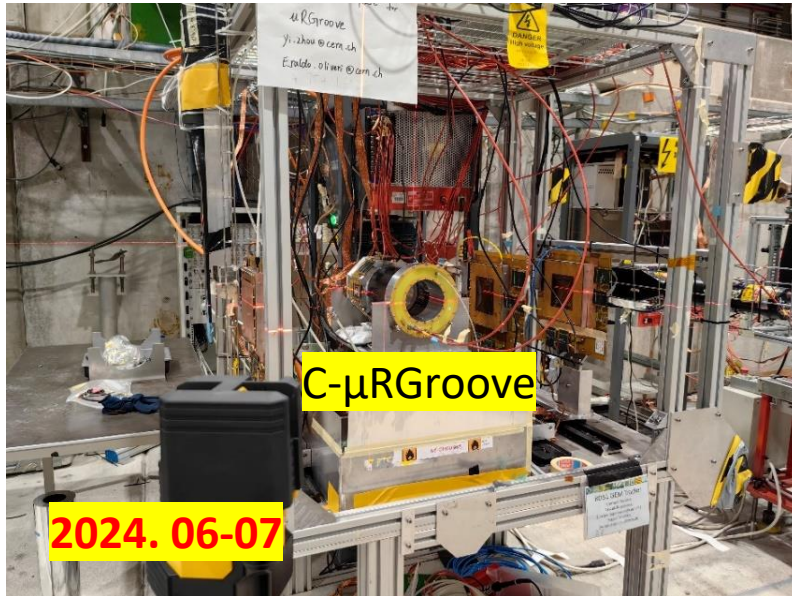
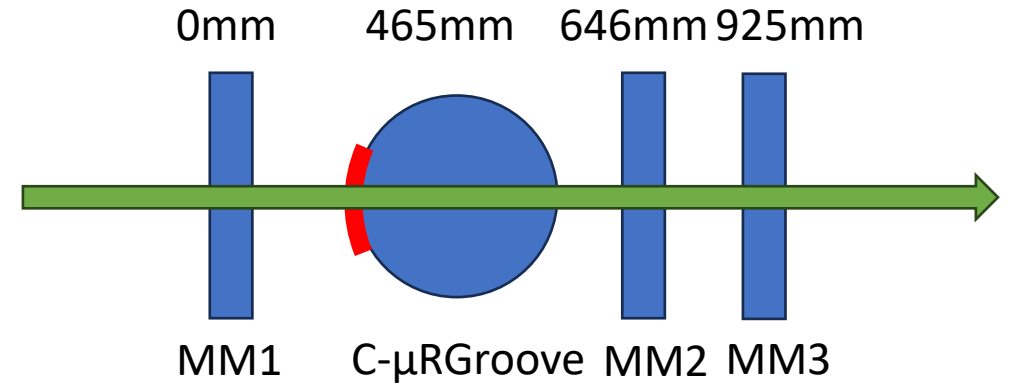
2021.09 - 2024.05: design and production



Beam test without magnetic field

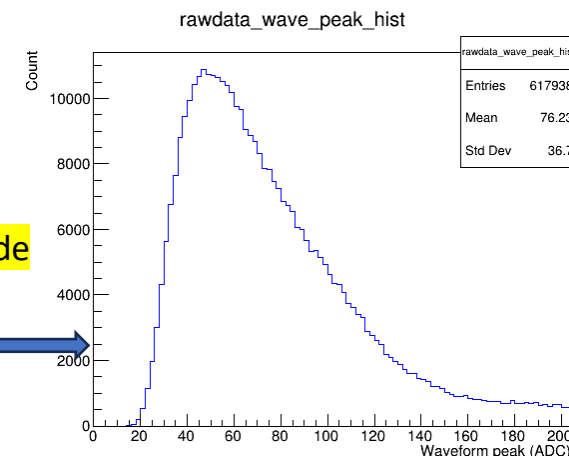
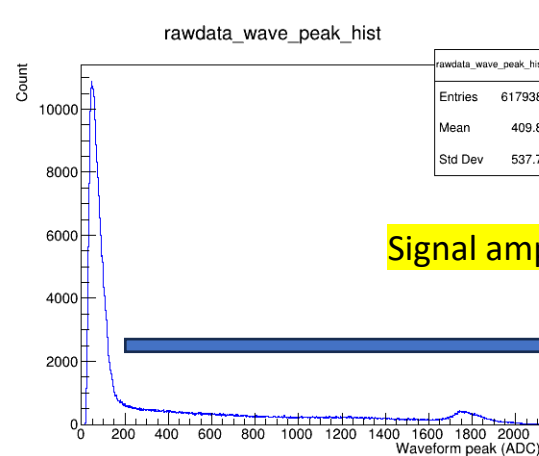
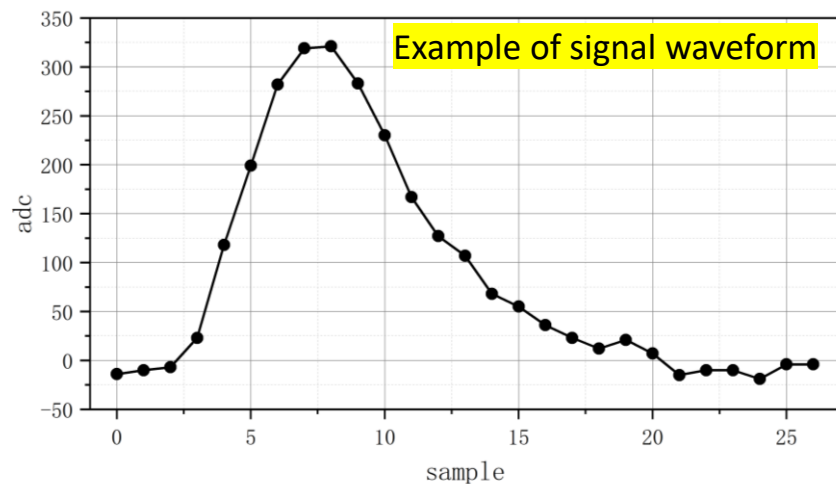
Setup:

- Gas: Ar:CF₄:CO₂/45:40:15
- Readout from U strips (top cooper of μ RGroove)
- V strips are grounded
- 3 micromegas trackers
- APV25+SRS+mmDAQ

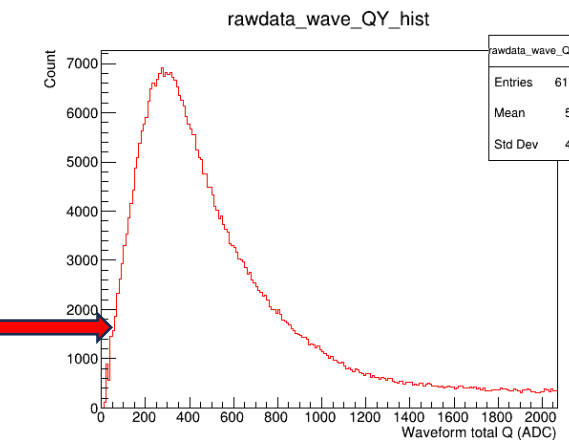
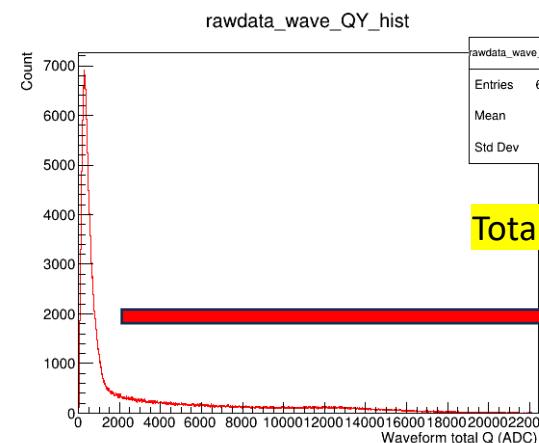


- The active area of the trackers is 6cm × 6cm, covering θ : $-27^\circ \sim 27^\circ$
- 1 sector of C- μ RGroove was readout, covering θ : $-22.5^\circ \sim 22.5^\circ$

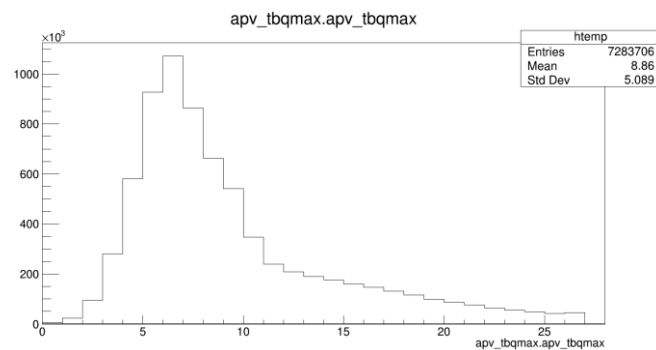
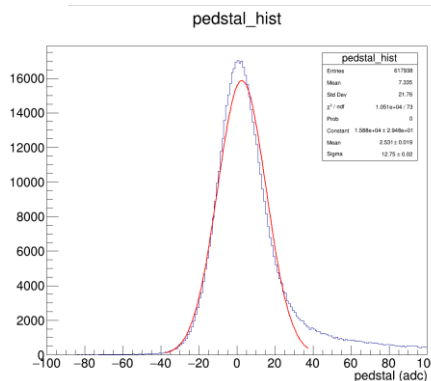
Analysis of raw data



Signal amplitude



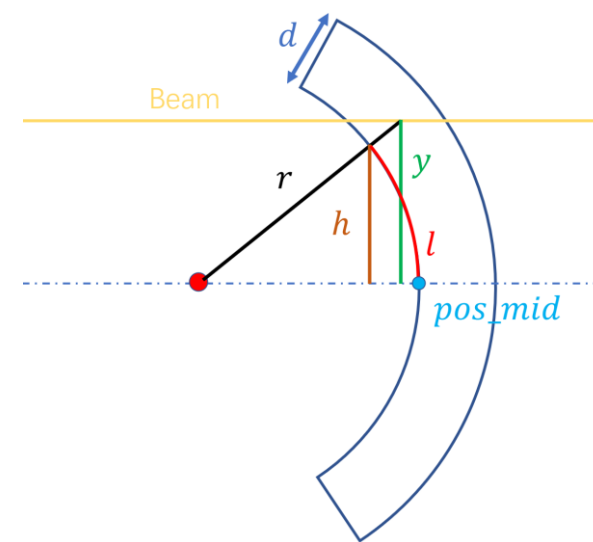
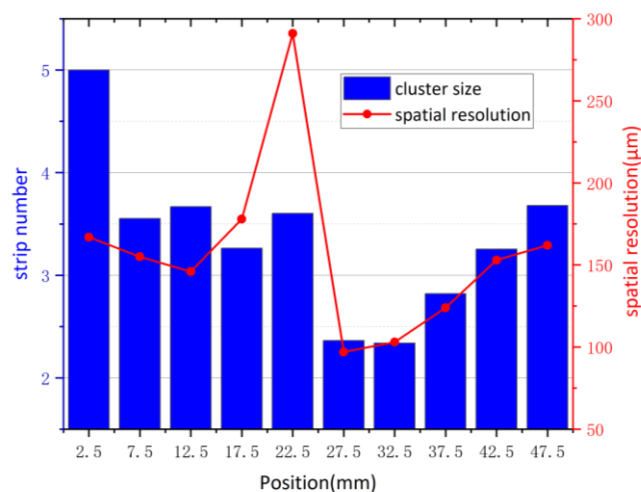
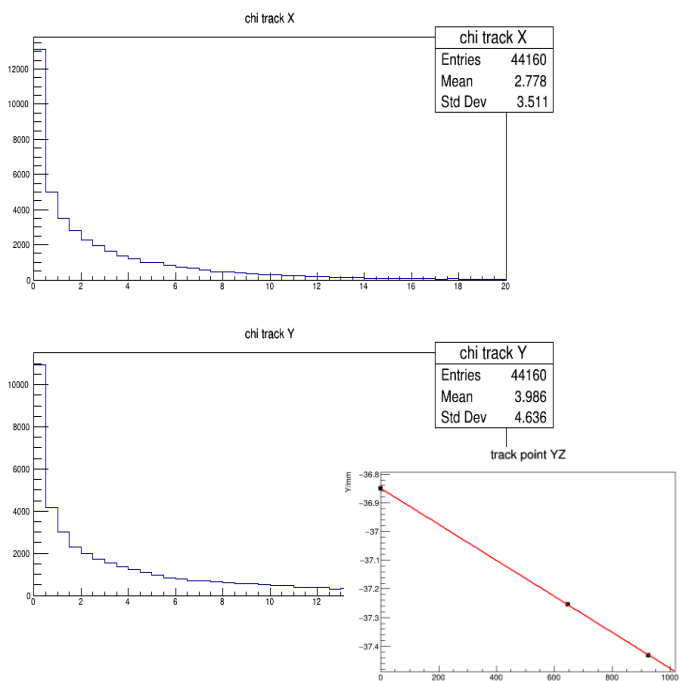
Total Q



- 25ns per sampling point, 27 sampling points in total
- Sigma of 1st sample point distribution: ~12(adc)
- Mean of signal Amplitude: ~410(adc)

CC for perpendicular tracks

- Charge Center of gravity(CC) for perpendicular tracks



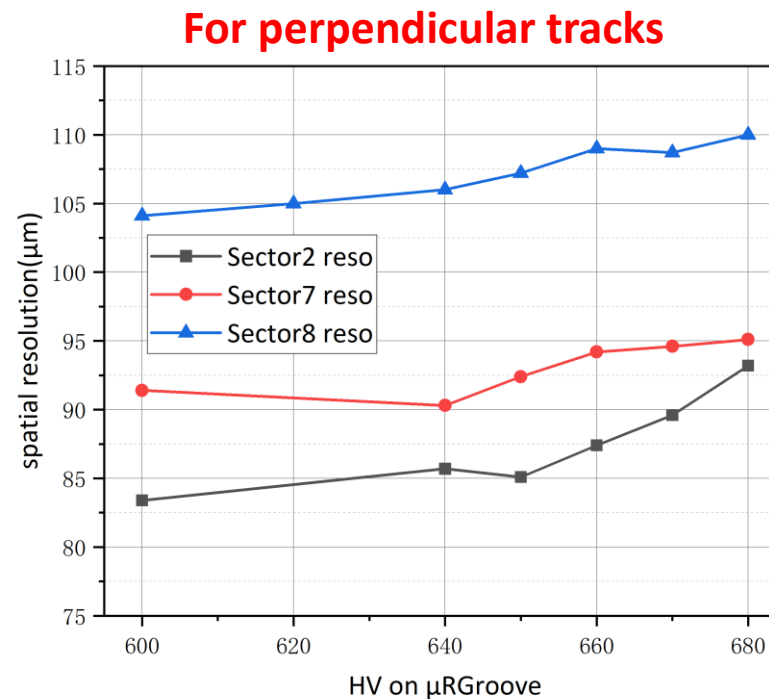
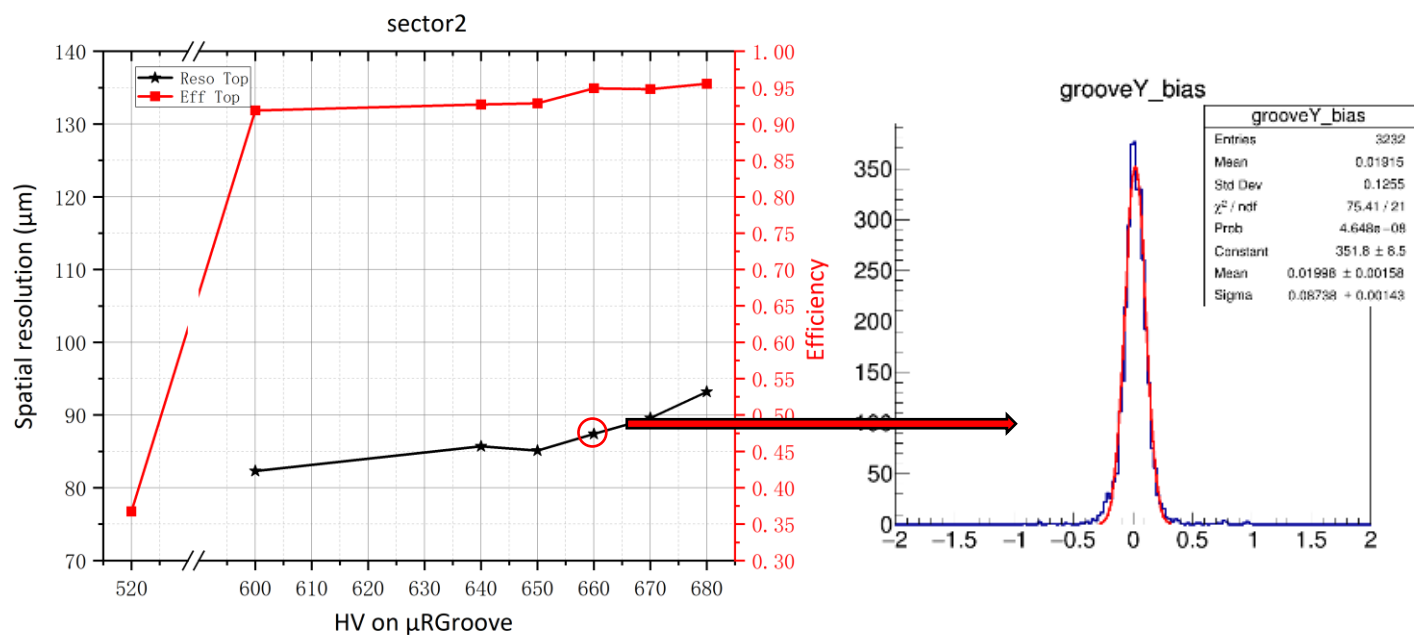
$$y = \left(r + \frac{d}{2} \right) \times \sin \frac{l}{r} + pos_mid$$

l : reconstructed position
 y : truth hit position
 pos_mid : middle point

- Track fitting: Chi-square <10

- ✓ Find the middle area.
- ✓ Alignment and rotation correction
- ✓ Position correction of circular surface
- X **Wrinkles may degrade spatial resolution**

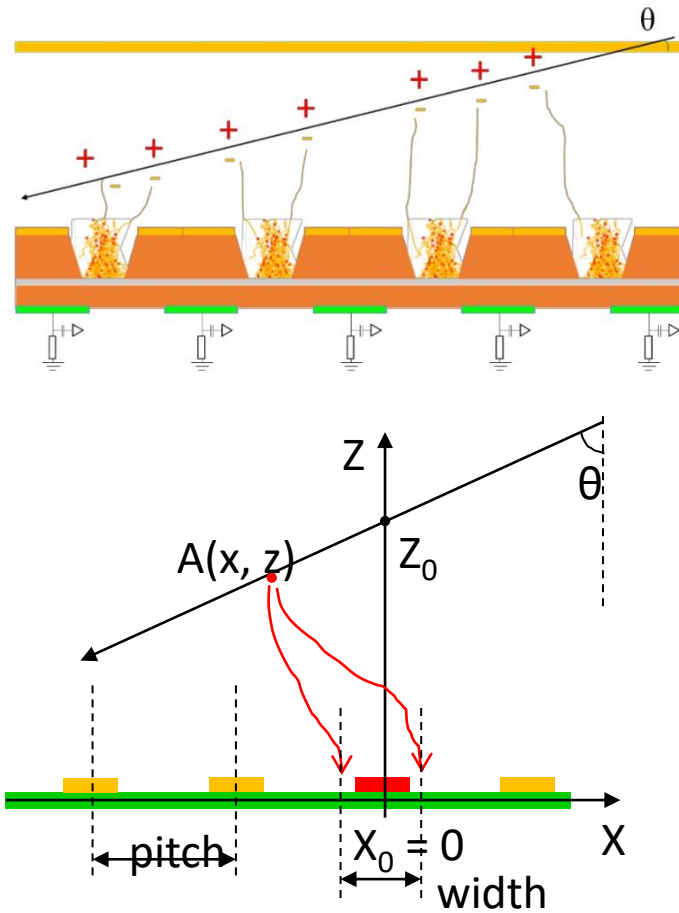
Detection efficiency and spatial resolution



- ✓ Spatial resolution for perpendicular tracks: 83~93 μ m.
- ✓ Detection efficiency >95%.

X Uniformity issues for different sectors

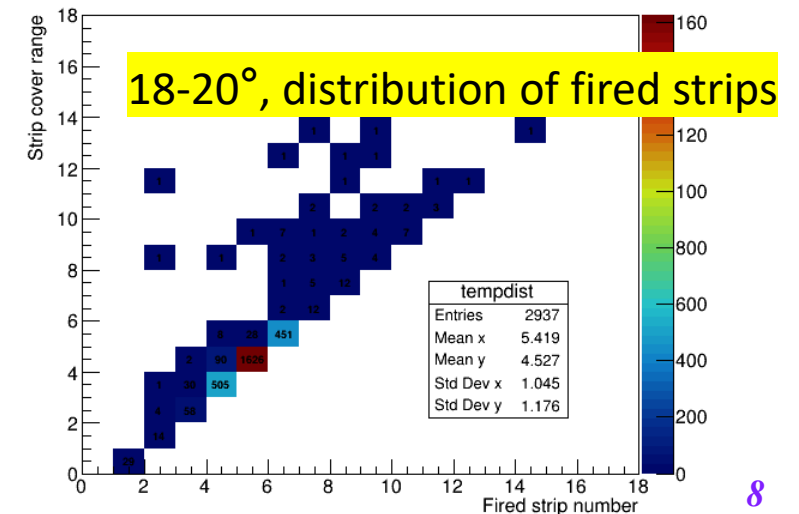
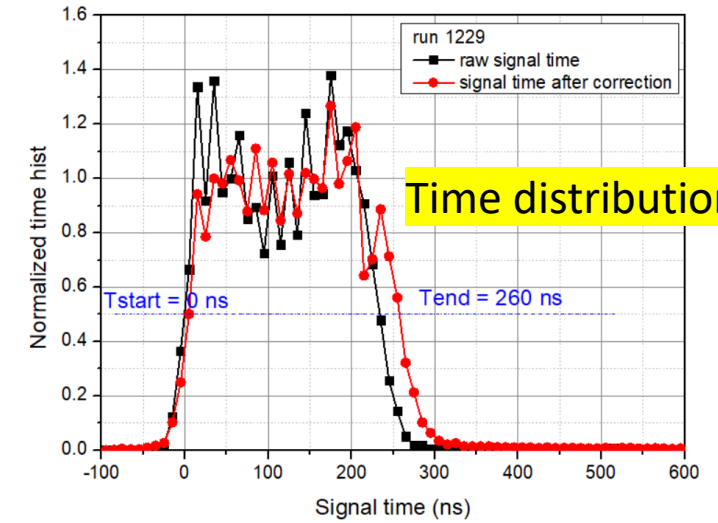
micro-TPC mode



μ TPC

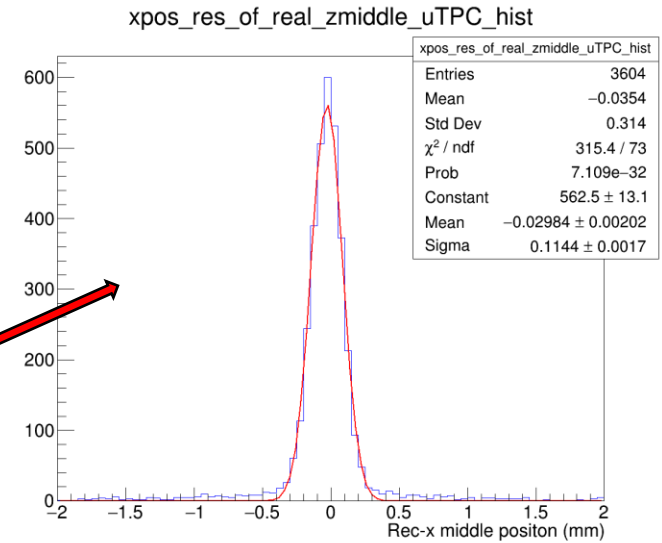
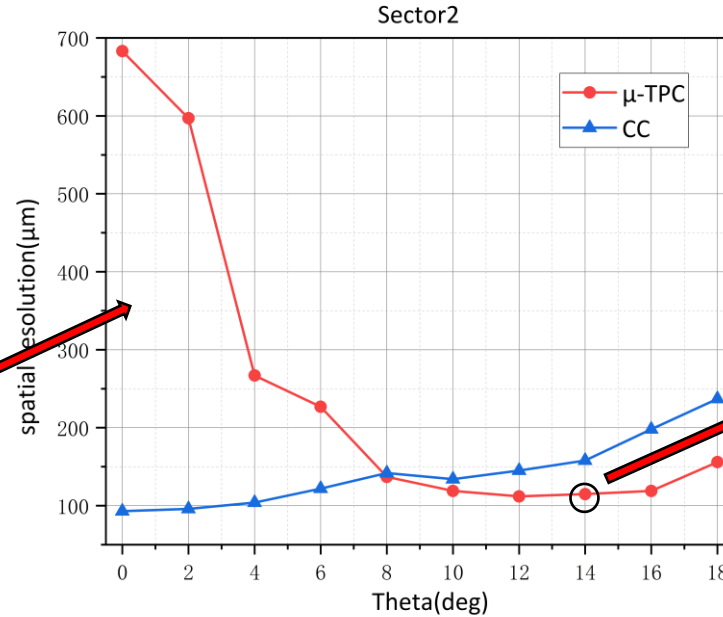
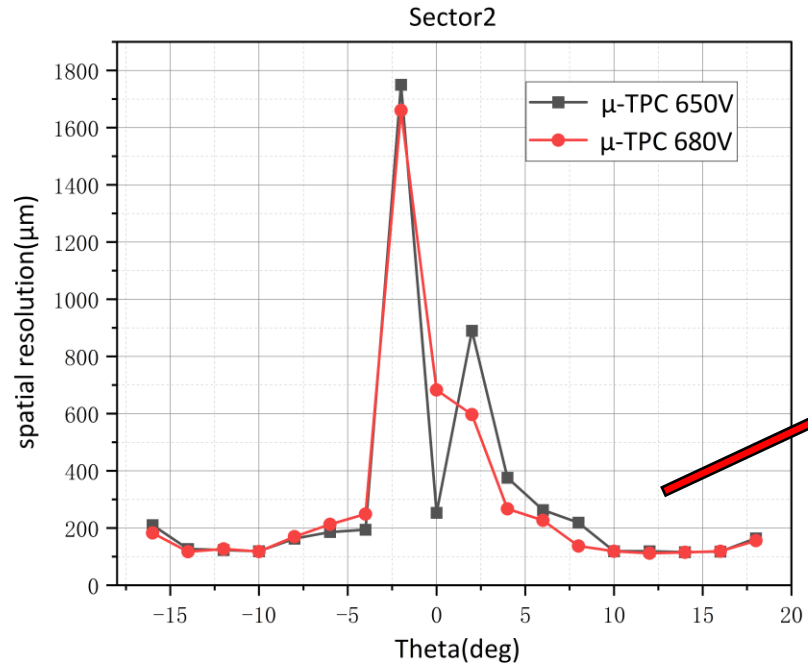
- Constant ratio timing
- Time advance correction
- Cluster finding
- X-T Fitting

The timing advance effect is mainly caused by horizontal diffusion. For more details, please refer to this poster from the MPGD2024.



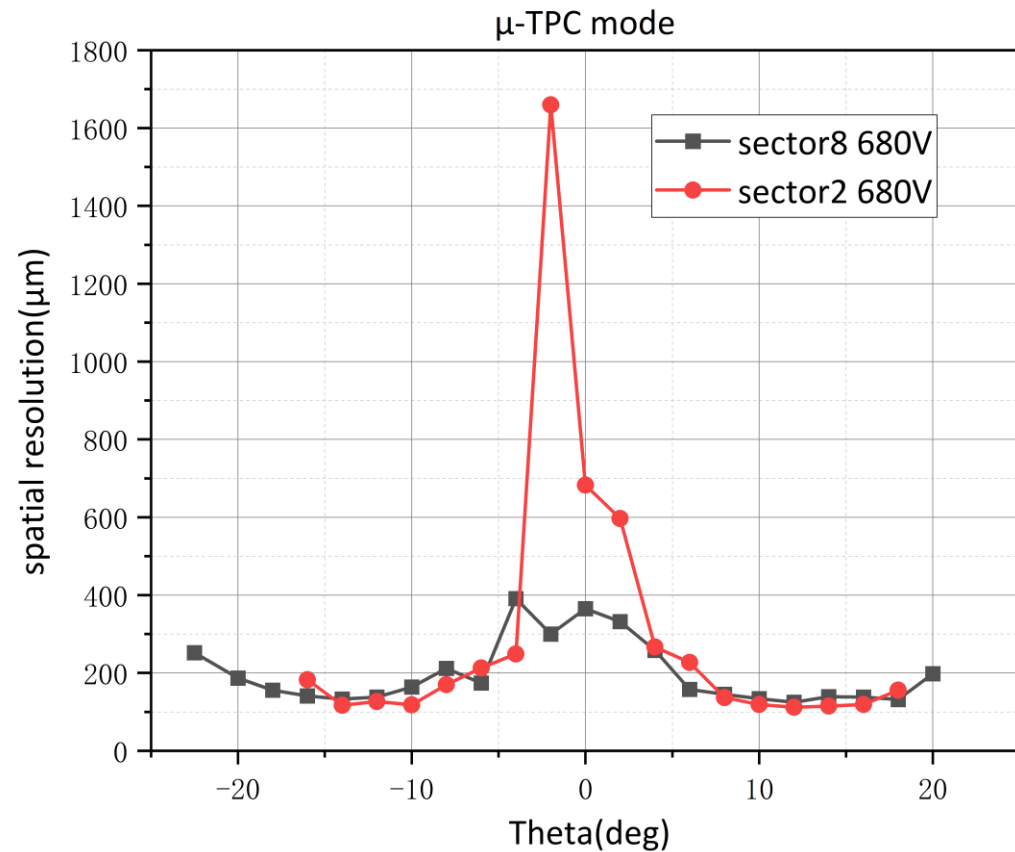
[Zhujun Fang, MPGD2024, Study on the bias analysis and correction in MPGD \$\mu\$ TPC mode](#)

Result of micro-TPC mode



✓ CC is better when the track incident angle is $< 8^\circ$, μ TPC is better when it is $> 8^\circ$, and the best result is better than $120\mu\text{m}$

Result of different sectors

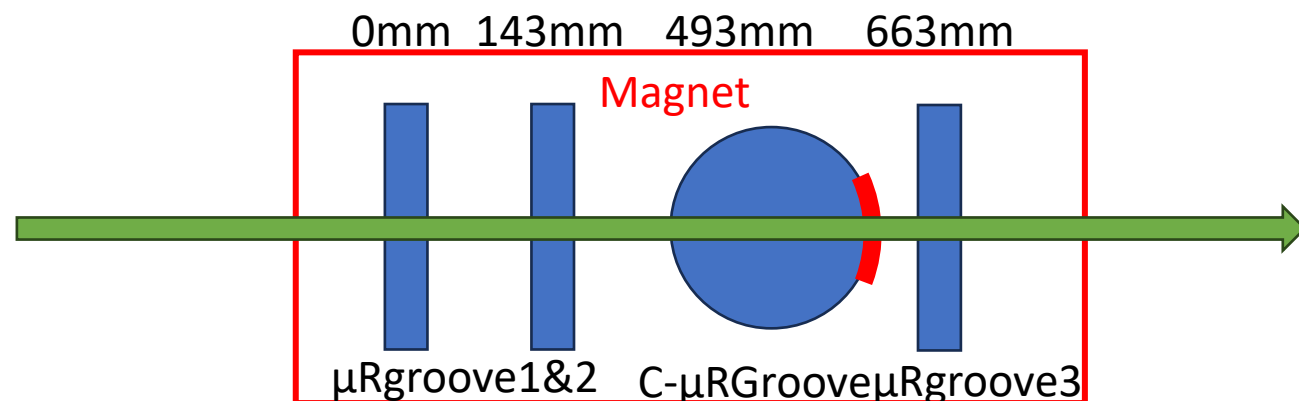
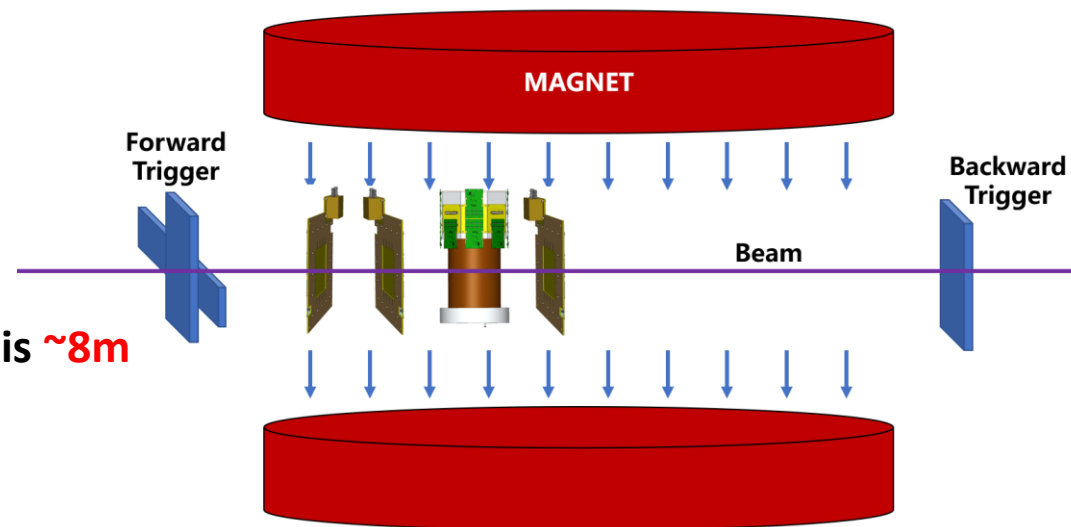


- The results of sector 2 are **slightly** better than those of sector 8.

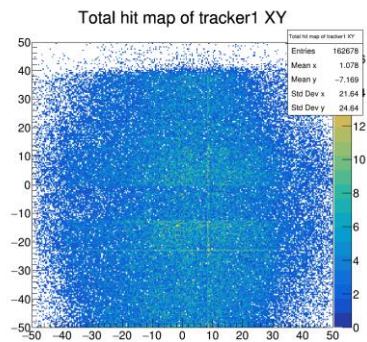
Beam test with magnetic field

Setup:

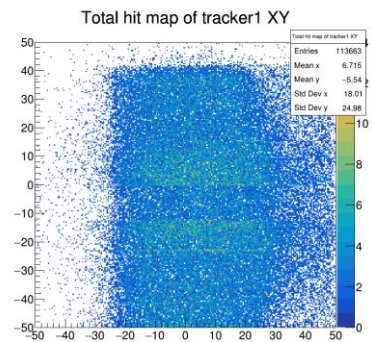
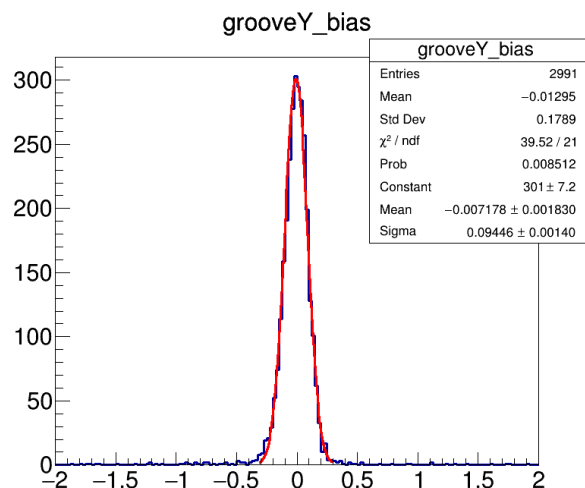
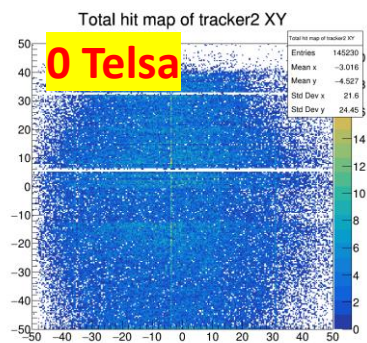
- Gas: Ar:CF₄:CO₂/45:40:15
- Readout from X strips (cathode)
- V strips are grounded
- APV25+SRS+mmDAQ
- Distance between forward and backward triggers is **~8m**
- **3 μ RGroove trackers**
- **0.5-1.5Tesla magnetic field**



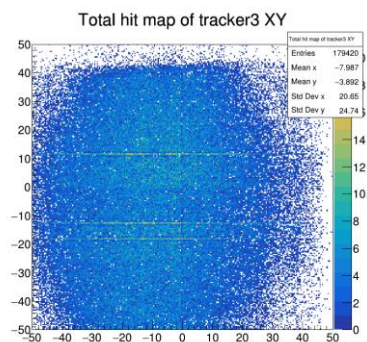
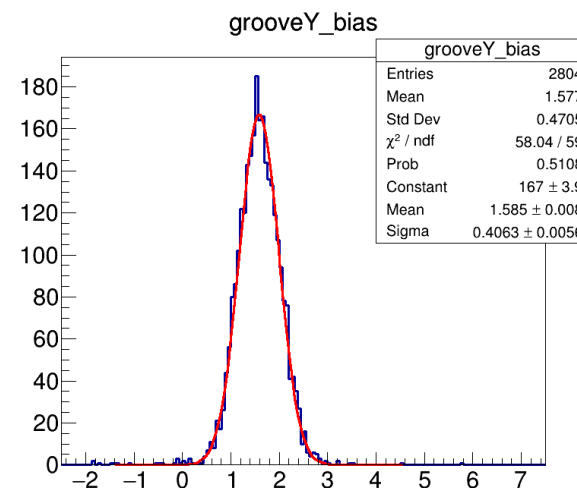
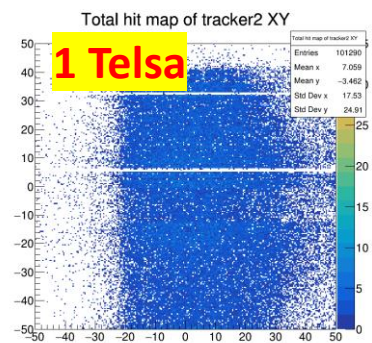
Beam test with magnetic field



For perpendicular tracks, CC method



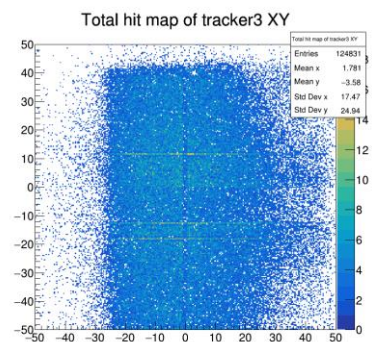
For perpendicular tracks, CC method



Spatial resolution is $\sim 94\mu\text{m}$ as a reference @B=0T

For 150GeV/c muon, $m \approx P$

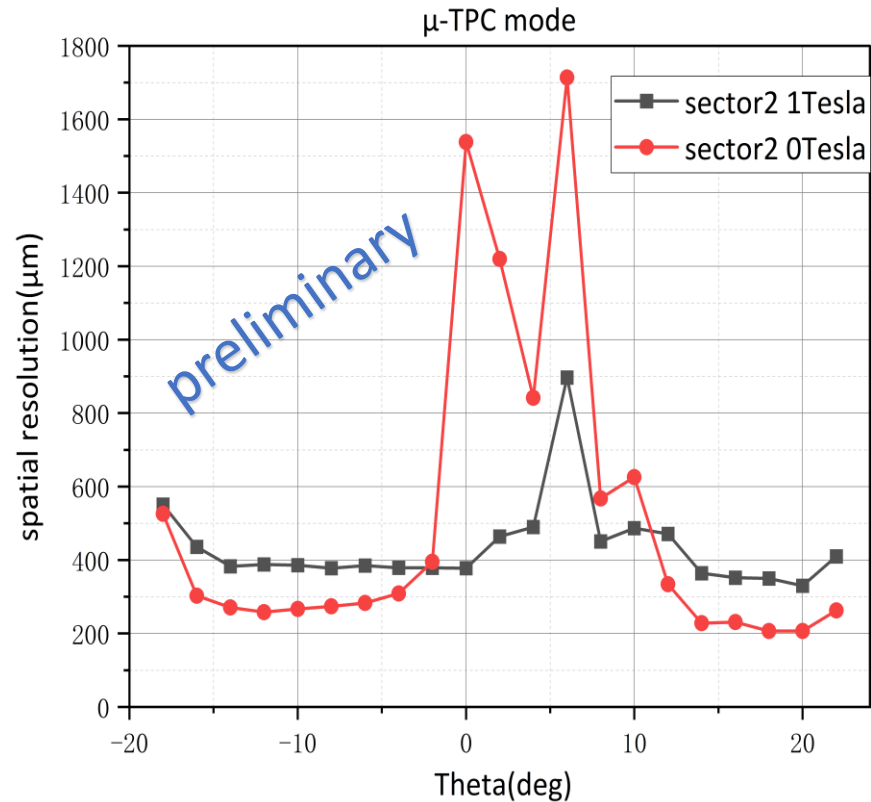
$$r = \frac{mv}{Bq} \approx 500m \text{ @B=1T}$$



Spatial resolution is $\sim 400\mu\text{m}$
 Bias: $\sim 1.592\text{mm}$, sigma: $\sim 400\mu\text{m}$
Lorenz angle: $\sim 17.7^\circ$

Trackers' hit map shift caused by long distance between triggers.

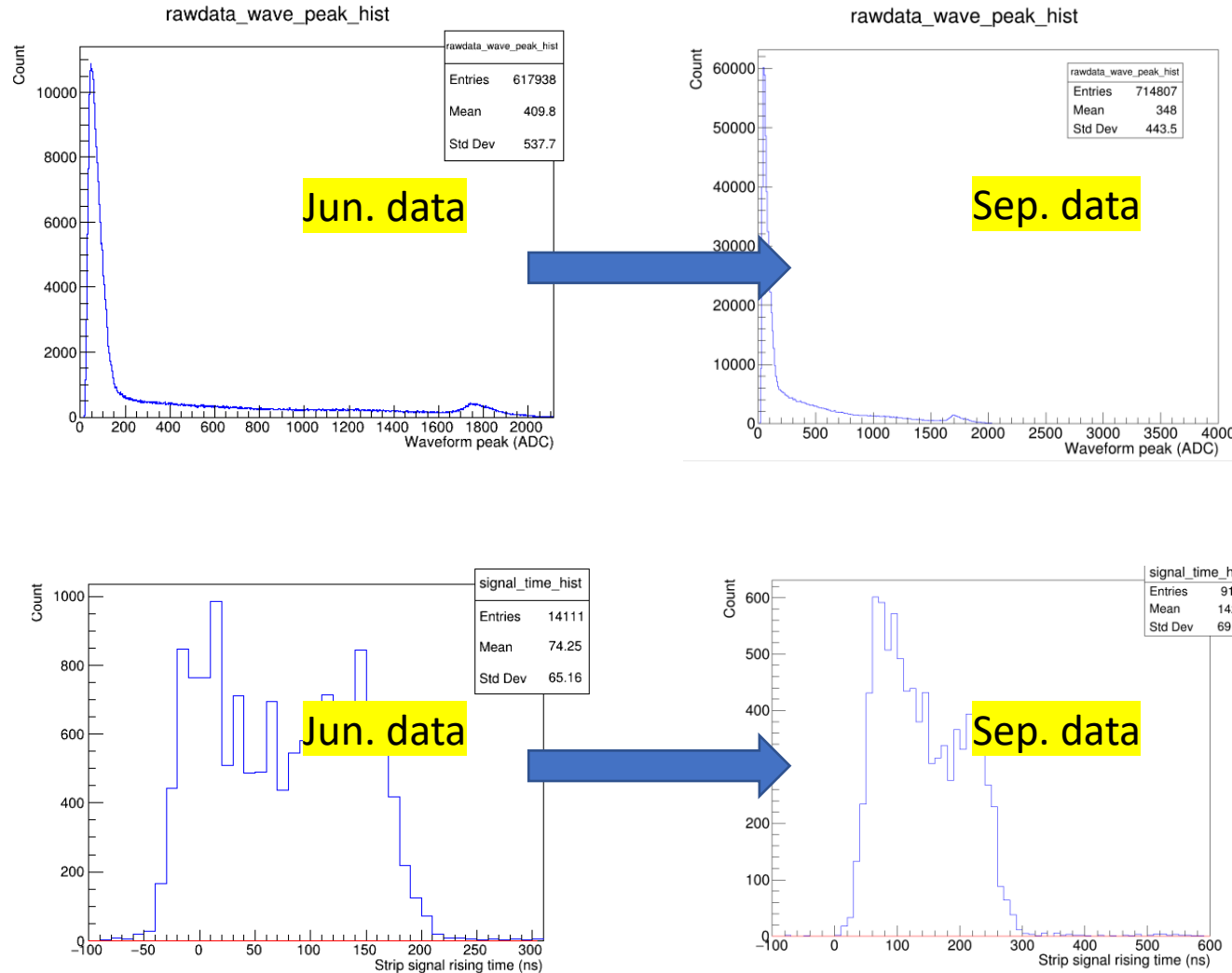
Preliminary result with magnetic field



Very preliminary results:

- Without magnetic field, the best result is **$\sim 200\mu\text{m}$** , which may be related to gas changes.
- With 1T magnetic field, the best result is **$\sim 330\mu\text{m}$** , which is significantly worse, indicating that the correction of the Lorentz angle is incomplete
- Further corrections are still needed

Comparison of June and September data



- The signal amplitude drops by about 15%

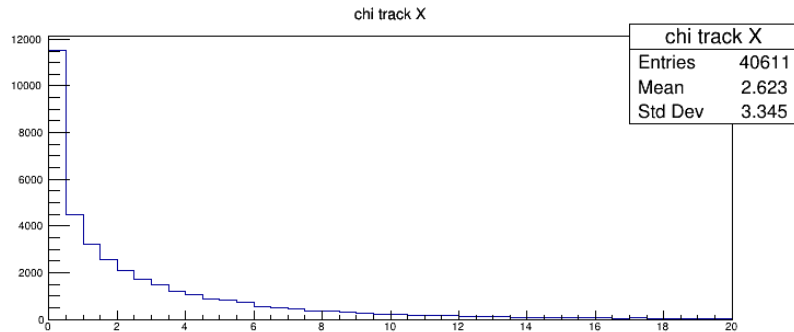


- Under the same voltage setting, the **gain becomes smaller** and the **drift velocity becomes faster**, which may be due to changes in gas composition.

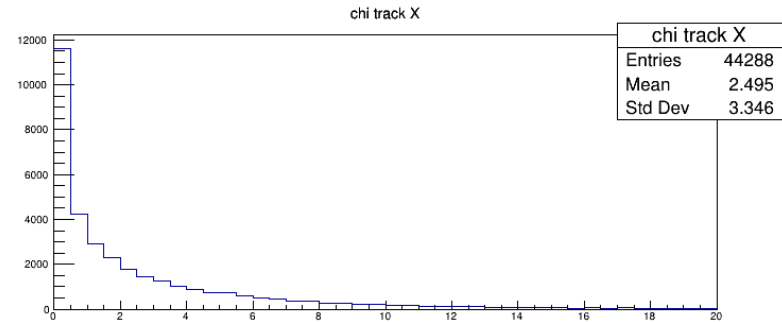


- (Tmax-Tmin) reduced by 40ns

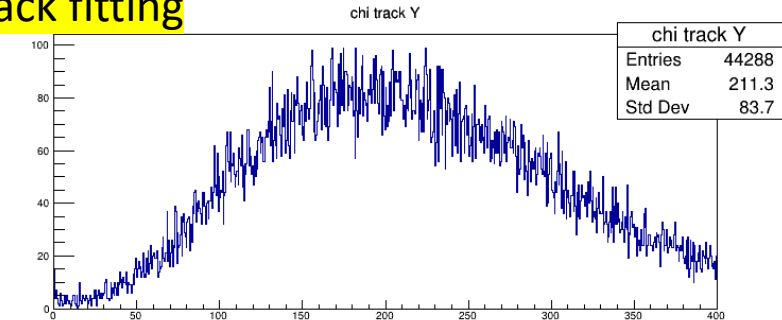
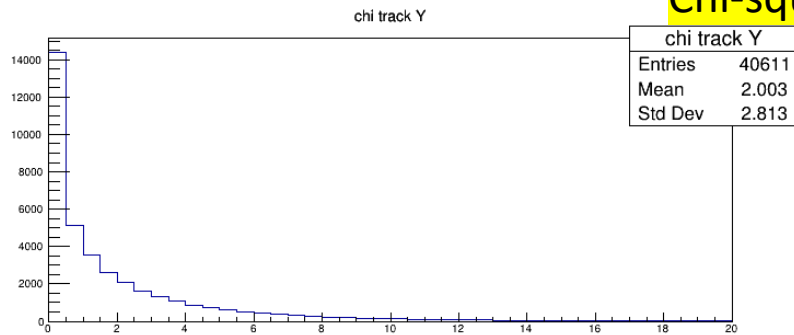
Effect of magnetic field on trackers



Sep. data



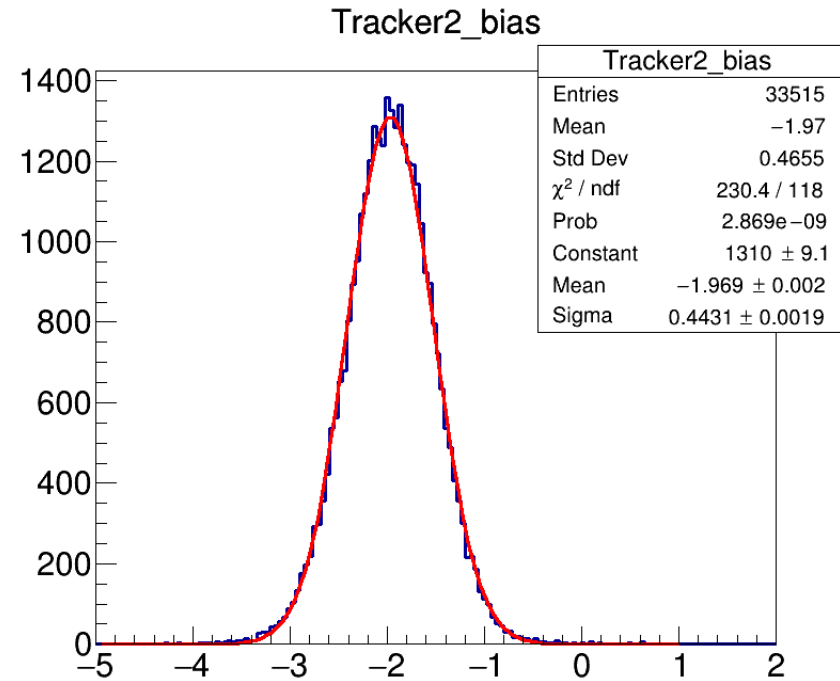
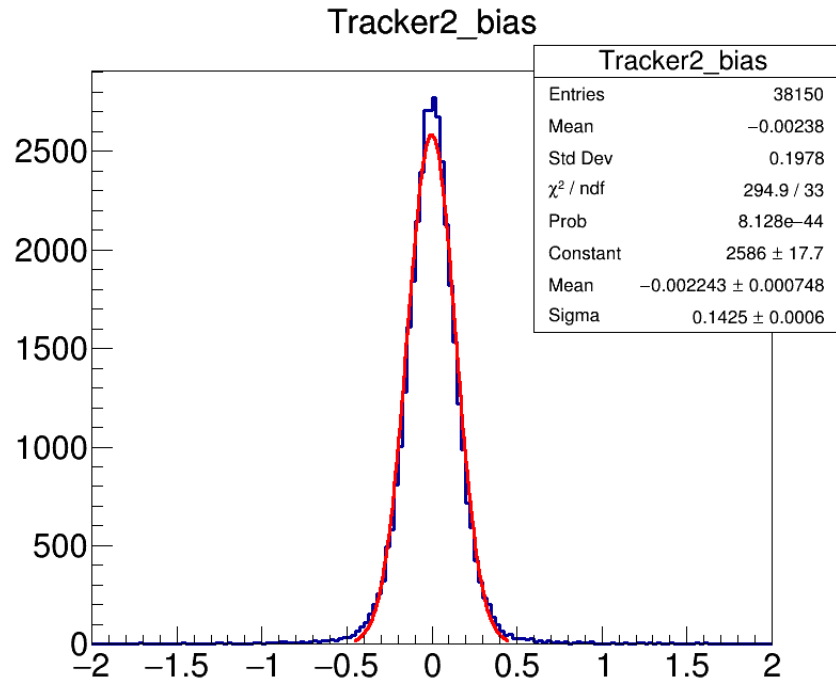
Chi-square distribution of track fitting



OT: Track fitted well

1T: The track quality become worse and the trackers were affected by the magnetic field, especially the primary electron drift process.

Effect of magnetic field on trackers



Use Tracker 1 and 3 to fit the tracks and calculate the spatial resolution of tracker 2

0T: 143 μ m

1T: 443 μ m

➤ **Magnetic fields have a significant impact on tracker system**

Summary

- Spatial resolution without magnetic field:
 - $<100\mu\text{m}$ for perpendicular tracks
 - $<120\mu\text{m}$ for Oblique incident tracks
- In the September beam test, CC result for perpendicular tracks is $<100\mu\text{m}$, while μTPC results were significantly worse, which may be caused by gas changes.
- Data analysis of magnetic field tests is still in progress
- **Beam test with magnetic field is required for next year**



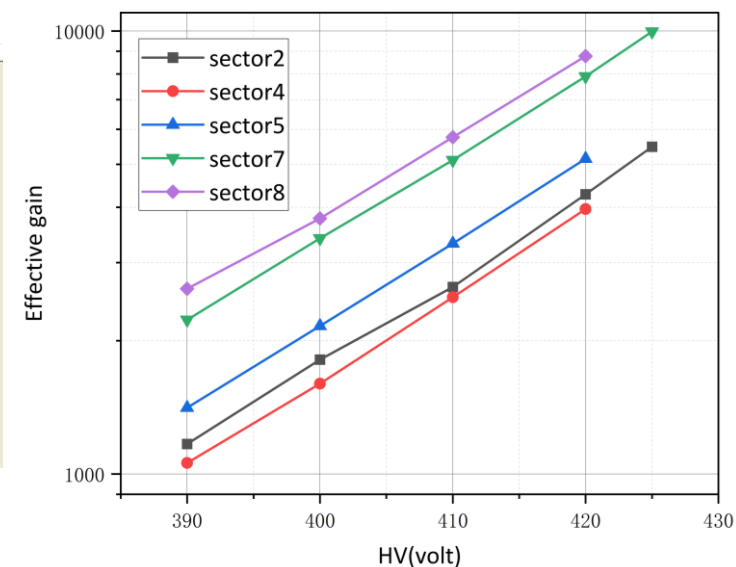
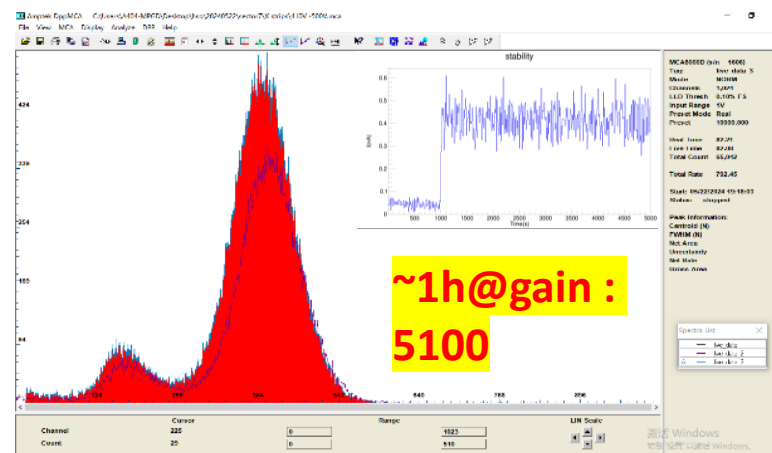
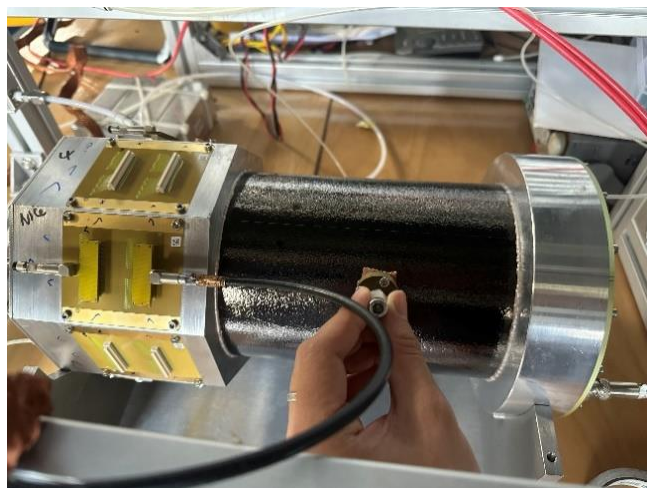


BACKUP

Gain and energy spectrum measurement

Setup:

- Gas: Ar:iC₄H₁₀/95:5
- Source: ⁵⁵Fe
- Readout from X strips (cathode)
- V strips are grounded
- Ortec142AH/671 + MCA
- Gain measured by signal amplitude spectrum



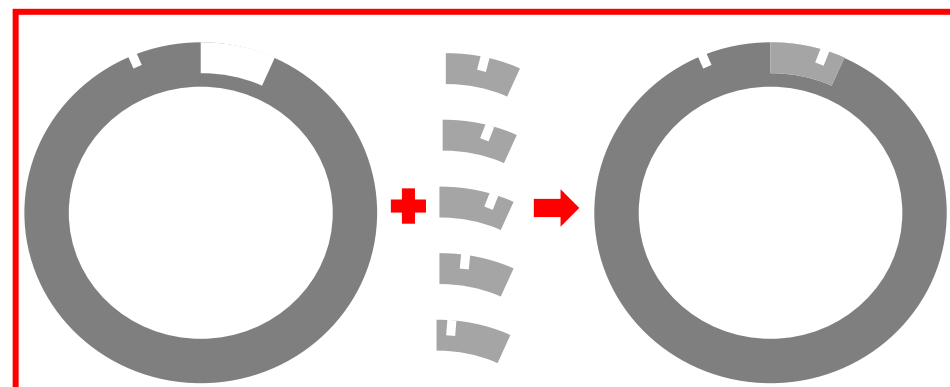
- ✓ Energy resolution: ~26%;
- ✓ Effective gain: 4000~10000;
- ✓ Similar signal amplitude on X&V readout strips;
- ✓ Good stability if the humidity can keep low enough;
- ✗ 3 sectors not work (8 sectors in total);
- ✗ Bad gain uniformity, caused by the gas(flow);

Redesign alignment holes to reduce the wrinkling



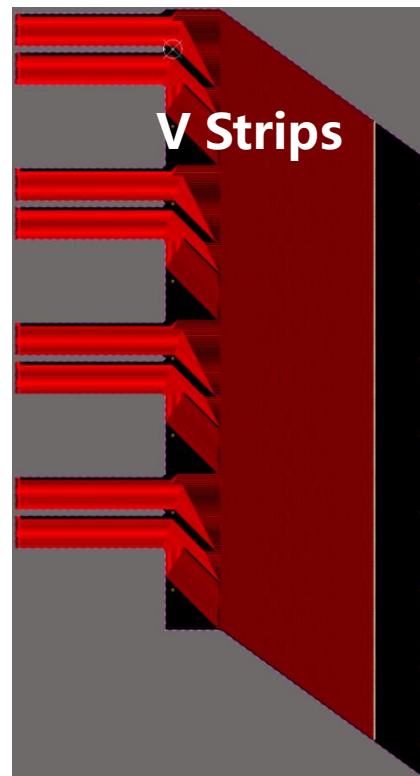
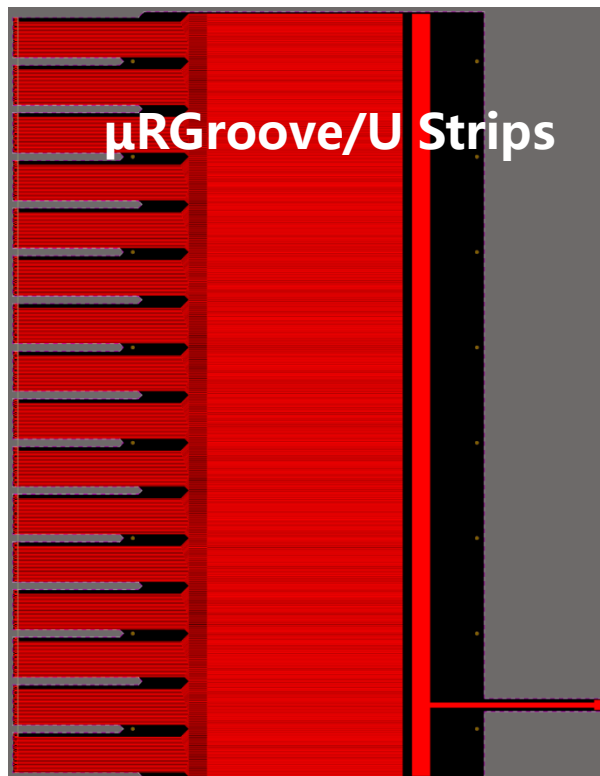
Impossible to predict the position of alignment holes

- × The fabrication tolerance of the detector parts in different batch;
- × Alignment accuracy during the detector assembling;
- × Tolerance of the Rohecall thickness and gluing process;

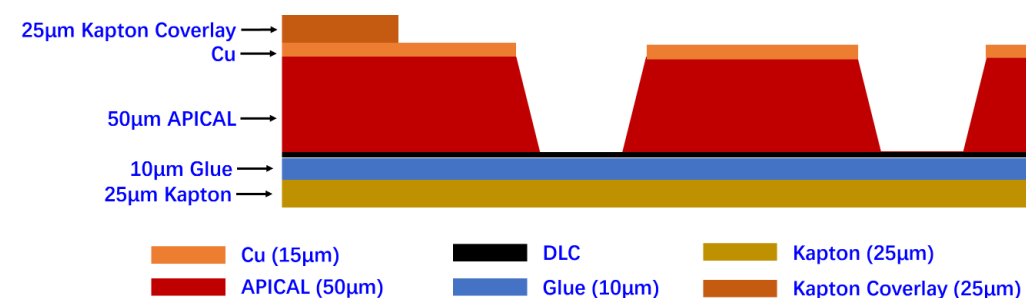


- ✓ This design can eliminate all the tolerance, we can even measure where the alignment holes should be before the foil gluing, then made the correct alignment parts.

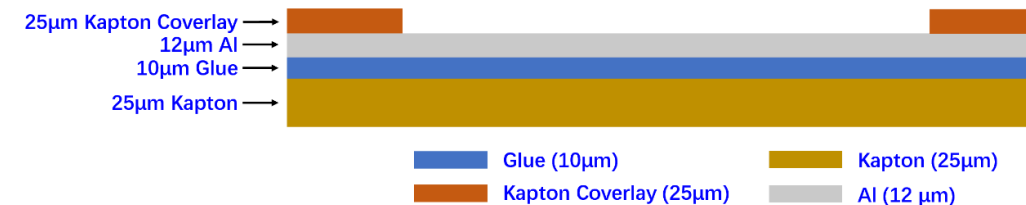
μRGroove and Readout Strips



Layer stack of μRGroove

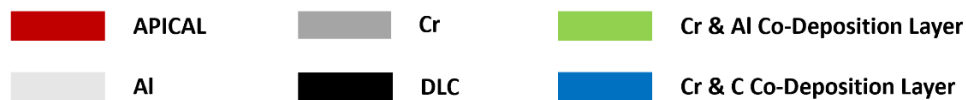
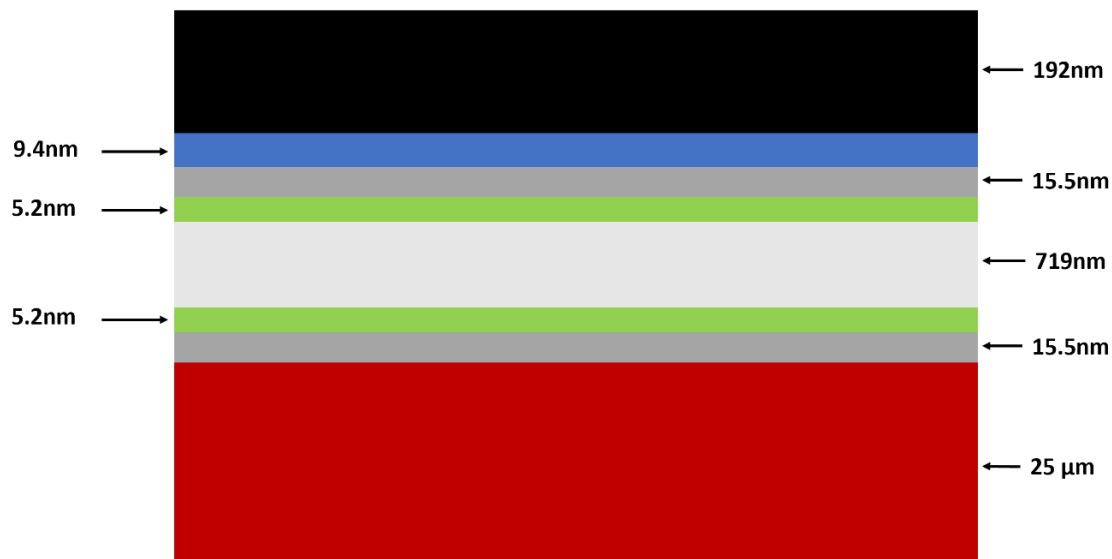


Layer stack of V readout

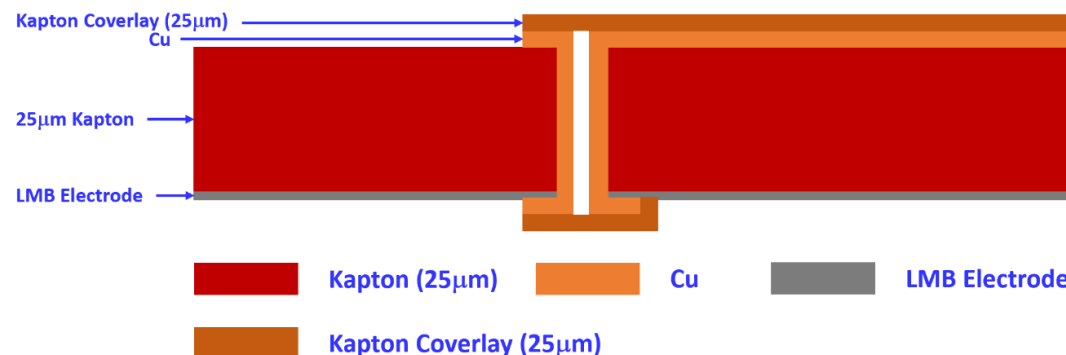


- U/V 2D strip-readout. Pitch: U strip is 0.4mm, V strip is 0.8mm, angel between UV is 15° .
- 2 PCBs each containing 1d strips are used.
- 25μm Kapton substrate
- Aluminum V-strips

Low-mass electrode



Layer stack of drift electrode



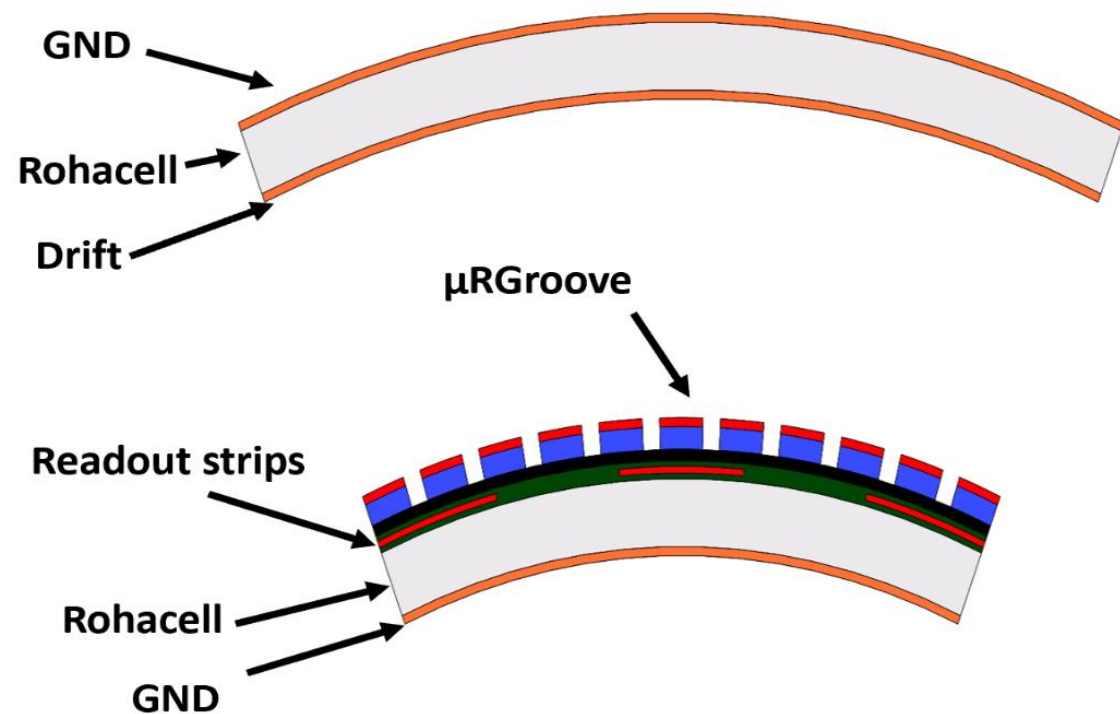
Layer stack of GND electrode



- Low-mass electrode used for both drift and GND

	X0 (mm)	Thickness (nm)	Material Budget (%X0)
C	188.4	193.6	0.0001028
Al	88.97	721.6	0.0008110
Cr	20.7	46.5	0.0002246
Total:			0.0011384

Material budget



C- μ RGroove

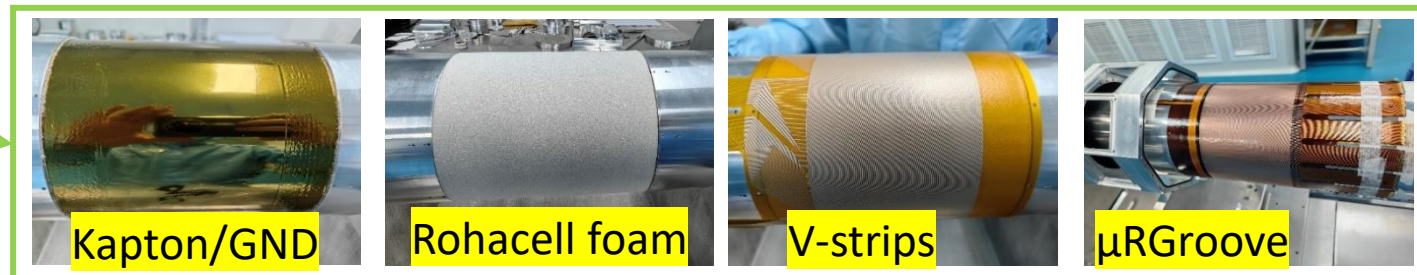
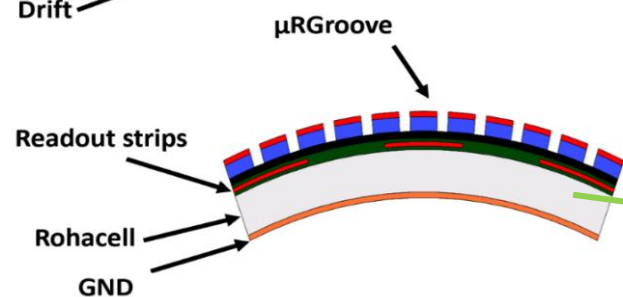
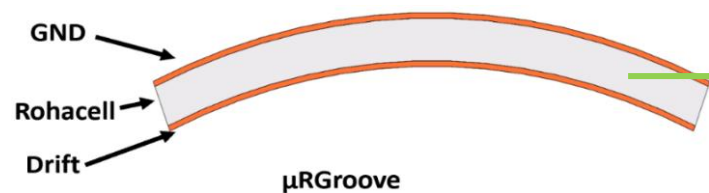
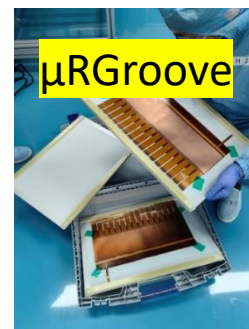
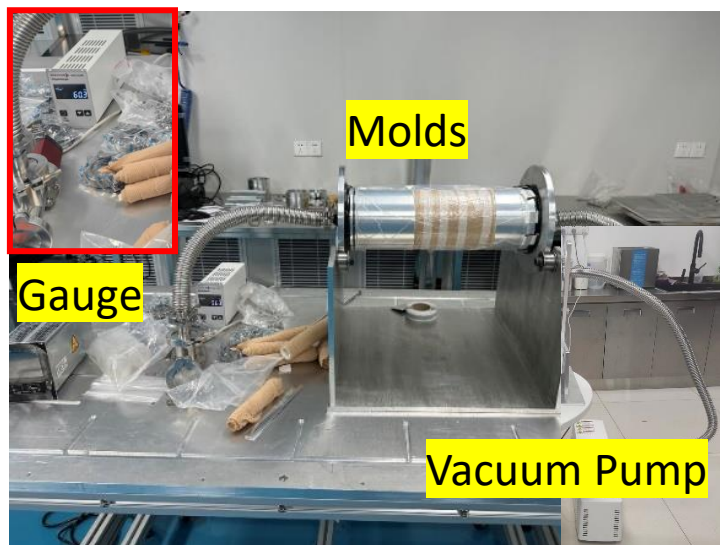
Structure	Material	Thickness (cm)	Material budget (X0)
Drift electrode	LMB-GND	---	2*0.001138%
	Polyimide (X0=28.57cm)	0.0025*2	0.0175%
	Glue (X=20cm)	0.001*2	0.01%
	Rohacell (X0=689cm)	0.2	0.029%
Gas volume	Argon-based gas mixture (X0=11760cm)	0.5	0.00425%
Inner cylinder (μ RGroove foil)	Cu (X0=1.43cm)	0.0015*65%	0.0682%
	Cr (X0=2.077cm)	0.000001*65%	0.0000313%
	Apical (X0=28.57cm)	0.005*70%	0.01225%
	Glue (X0=20cm)	0.001*5	0.025%
	Kapton (X0=28.57cm)	0.0025*2	0.0175%
	Al (X0=8.892cm)	0.0012*(1*32.5%)	0.00439%
	DLC (X0=12.13cm)	0.0001	0.00082%
	Polyimide (X0=28.57cm)	0.0025	0.00875%
	Rohacell (X0=689cm)	0.2	0.029%
	LMB-GND	---	0.001138%
Total			0.2301%

Consider Low-mass electrode, foams and bonding glues:

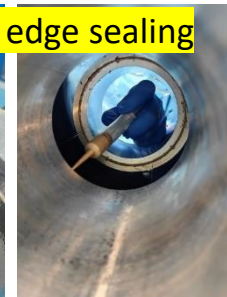
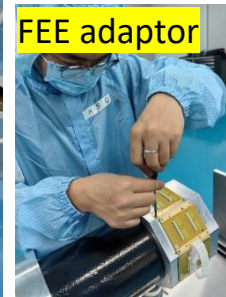
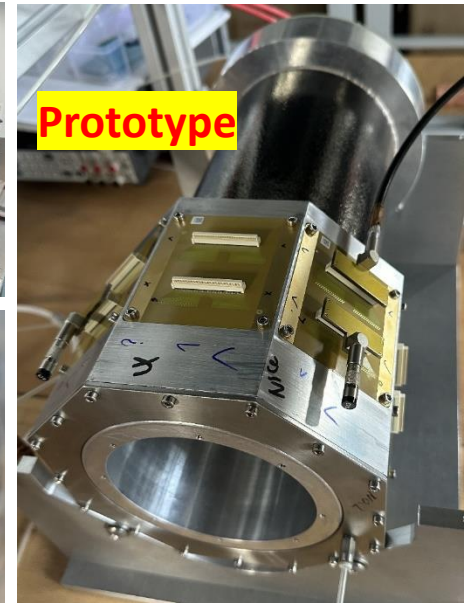
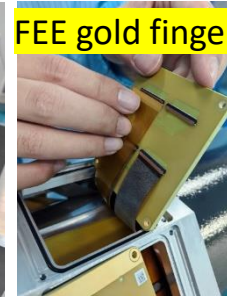
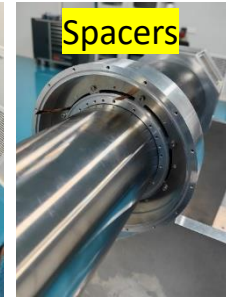
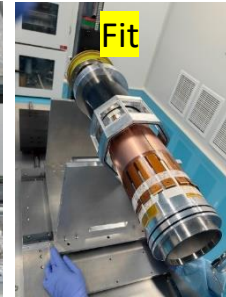
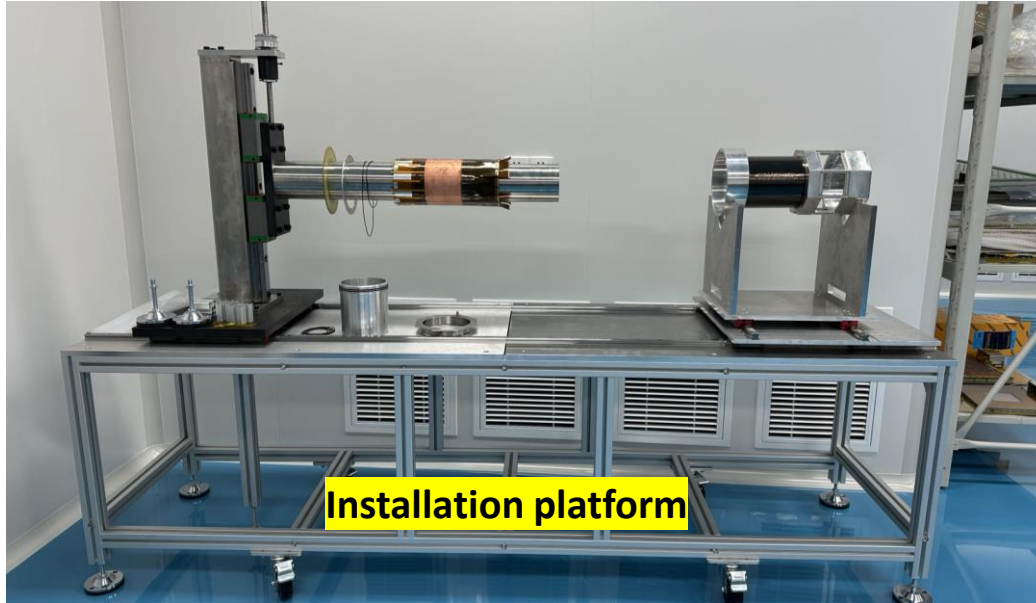
✓ Total material budget: $\sim 0.23\%X_0$

Electrode gluing process

- ✓ Vacuum gluing system
- ✓ The uniform thin glue process: **thickness of glue film <math>< 10\mu\text{m}</math>**



Detector assembling



- ✓ An installation platform is designed
- ✓ Reversible installation process

